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# **FDP8870**

# N-Channel PowerTrench<sup>®</sup> MOSFET 30V, 156A, $4.1 m\Omega$

## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{\text{DS}(\text{ON})}$  and fast switching speed.

# **Applications**

DC/DC converters



#### **Features**

- $r_{DS(ON)} = 4.1 m\Omega$ ,  $V_{GS} = 10V$ ,  $I_D = 35A$
- $r_{DS(ON)} = 4.6 m\Omega$ ,  $V_{GS} = 4.5 V$ ,  $I_D = 35 A$
- High performance trench technology for extremely low rDS(ON)
- · Low gate charge
- High power and current handling capability
- · RoHS Compliant







# $\textbf{MOSFET Maximum Ratings} \ \, \textbf{T}_{C} = 25^{\circ}\text{C unless otherwise noted}$

| Symbol                            | Parameter  | Ratings    | Units |  |
|-----------------------------------|--|------------|-------|--|
| $V_{DSS}$                         | Drain to Source Voltage  | 30         | V     |  |
| V <sub>GS</sub>                   | Gate to Source Voltage   | ±20        | V     |  |
| I <sub>D</sub>                    | Drain Current  |            |       |  |
|                                   | Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 10V$ ) (Note 1)                                   | 156        | Α     |  |
|                                   | Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 4.5V$ ) (Note 1)                                  | 147        | Α     |  |
|                                   | Continuous ( $T_{amb} = 25^{\circ}C$ , $V_{GS} = 10V$ , with $R_{\theta JA} = 62^{\circ}C/W$ ) | 19         | А     |  |
|                                   | Pulsed   | Figure 4   | Α     |  |
| E <sub>AS</sub>                   | Single Pulse Avalanche Energy (Note 2)   | 300        | mJ    |  |
|                                   | Power dissipation  | 160        | W     |  |
| $P_{D}$                           | Derate above 25°C  | 1.07       | W/°C  |  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature  | -55 to 175 | °C    |  |

# Thermal Characteristics

| $R_{\theta JC}$   | Thermal Resistance Junction to Case TO-220              | 0.94 | °C/W |
|-------------------|---|------|------|
| R <sub>e,IA</sub> | Thermal Resistance Junction to Ambient TO-220 ( Note 3) | 62   | °C/W |

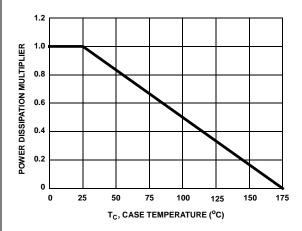
# **Package Marking and Ordering Information**

| Device Marking | Device                   | Package | Reel Size | Tape Width | Quantity |  |
|----------------|--------------------------|---------|-----------|------------|----------|--|
| FDP8870        | FDP8870 FDP8870 TO-220AB |         | Tube      | N/A        | 50 units |  |

| Symbol                                | Parameter                               | Test Conditions   | Min | Тур    | Max    | Units |
|---------------------------------------|---|---|-----|--------|--------|-------|
| Off Chara                             | cteristics                              |   |     |        |        |       |
| B <sub>VDSS</sub>                     | Drain to Source Breakdown Voltage       | $I_D = 250 \mu A, V_{GS} = 0 V$   | 30  | T -    | I - I  | V     |
| -1088                                 | Ziamite eeuree Zieunaeimi tenage        | V <sub>DS</sub> = 24V   | -   | -      | 1      |       |
| I <sub>DSS</sub>                      | Zero Gate Voltage Drain Current         | $V_{GS} = 0V$ $T_C = 150^{\circ}C$                                      | -   | -      | 250    | μΑ    |
| I <sub>GSS</sub>                      | Gate to Source Leakage Current          | V <sub>GS</sub> = ±20V  | -   | -      | ±100   | nA    |
| On Chara                              | cteristics                              |   | •   | •      |        |       |
| V <sub>GS(TH)</sub>                   | Gate to Source Threshold Voltage        | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$                                    | 1.2 | -      | 2.5    | V     |
| 03(111)                               |   | $I_D = 35A, V_{GS} = 10V$   | _   | 0.0034 | 0.0041 |       |
|                                       |   | $I_D = 35A, V_{GS} = 4.5V$  | -   | 0.0040 | 0.0046 | Ω     |
| r <sub>DS(ON)</sub>                   | Drain to Source On Resistance           | I <sub>D</sub> = 35A, V <sub>GS</sub> = 10V,<br>T <sub>.I</sub> = 175°C | -   | 0.0051 | 0.0065 |       |
| Dvnamic                               | Characteristics                         | ] 0   |     | I      |        |       |
| C <sub>ISS</sub>                      | Input Capacitance                       |   | -   | 5200   | -      | pF    |
| C <sub>OSS</sub>                      | Output Capacitance                      | $V_{DS} = 15V$ , $V_{GS} = 0V$ ,  | _   | 970    | -      | pF    |
| C <sub>RSS</sub>                      | Reverse Transfer Capacitance            | f = 1MHz  | _   | 570    | -      | pF    |
| R <sub>G</sub>                        | Gate Resistance                         | V <sub>GS</sub> = 0.5V, f = 1MHz  | -   | 2.1    | -      | Ω     |
| $Q_{g(TOT)}$                          | Total Gate Charge at 10V                | V <sub>GS</sub> = 0V to 10V   | -   | 106    | 132    | nC    |
| Q <sub>g(5)</sub>                     | Total Gate Charge at 5V                 | $V_{GS} = 0V \text{ to } 5V$  | -   | 56     | 69     | nC    |
| Q <sub>g(TH)</sub>                    | Threshold Gate Charge                   | $V_{DD} = 15V$  | -   | 5.0    | 6.5    | nC    |
| Q <sub>gs</sub>                       | Gate to Source Gate Charge              | $I_{\rm D} = 35A$<br>$I_{\rm d} = 1.0 \text{mA}$                        | -   | 15     | -      | nC    |
| Q <sub>gs2</sub>                      | Gate Charge Threshold to Plateau        | I <sub>g</sub> = 1.0mA  | -   | 10     | -      | nC    |
| Q <sub>gd</sub>                       | Gate to Drain "Miller" Charge           |   | -   | 23     | -      | nC    |
|                                       | Characteristics (V <sub>GS</sub> = 10V) |   | •   | •      |        |       |
| t <sub>ON</sub>                       | Turn-On Time                            |   | -   | -      | 168    | ns    |
| t <sub>d(ON)</sub>                    | Turn-On Delay Time                      |   | -   | 11     | -      | ns    |
| t <sub>r</sub>                        | Rise Time                               | $V_{DD} = 15V, I_{D} = 35A$   | -   | 105    | -      | ns    |
| t <sub>d(OFF)</sub>                   | Turn-Off Delay Time                     | $V_{GS} = 4.5V, R_{GS} = 3.3\Omega$                                     | -   | 70     | -      | ns    |
| t <sub>f</sub>                        | Fall Time                               |   | -   | 46     | -      | ns    |
| t <sub>OFF</sub>                      | Turn-Off Time                           |   | -   | -      | 173    | ns    |
| <br>Drain-Soເ                         | urce Diode Characteristics              |   |     |        |        |       |
| \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | Source to Drain Diode Voltage           | I <sub>SD</sub> = 35A   | -   | -      | 1.25   | V     |
| $V_{SD}$                              |   | I <sub>SD</sub> = 15A   | -   | -      | 1.0    | V     |
| t <sub>rr</sub>                       | Reverse Recovery Time                   | $I_{SD} = 35A$ , $dI_{SD}/dt = 100A/\mu s$                              | -   | -      | 37     | ns    |
| Q <sub>RR</sub>                       | Reverse Recovered Charge                | I <sub>SD</sub> = 35A, dI <sub>SD</sub> /dt = 100A/μs                   | -   | -      | 21     | nC    |

- Notes:
  1: Package current limitation is 80A.
  2: Starting T<sub>J</sub> = 25°C, L = 0.15mH, I<sub>AS</sub> = 64A, V<sub>DD</sub> = 27V, V<sub>GS</sub> = 10V.
  3: Pulse width = 100s.





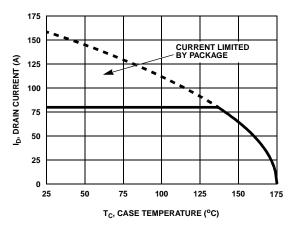


Figure 1. Normalized Power Dissipation vs Case Temperature

Figure 2. Maximum Continuous Drain Current vs Case Temperature

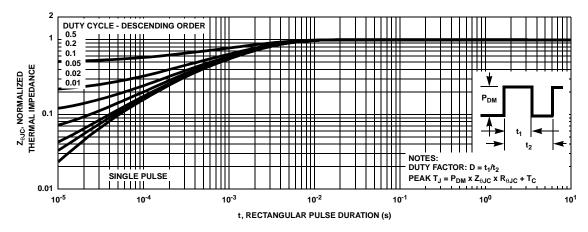


Figure 3. Normalized Maximum Transient Thermal Impedance

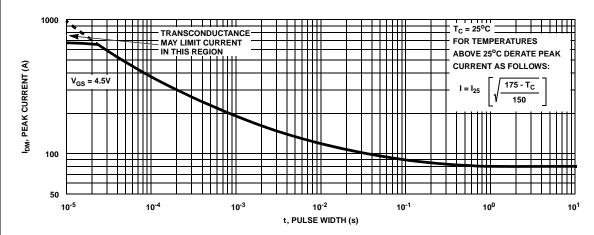
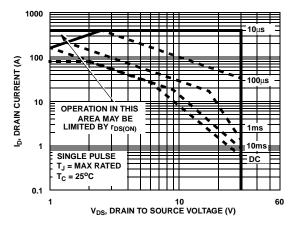


Figure 4. Peak Current Capability

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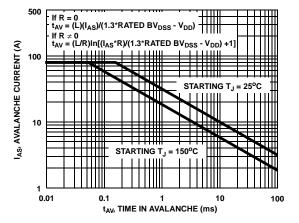
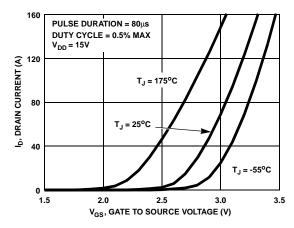


Figure 5. Forward Bias Safe Operating Area

NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability



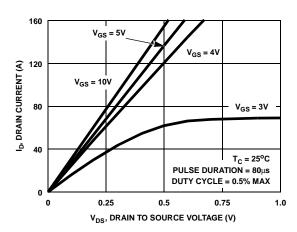
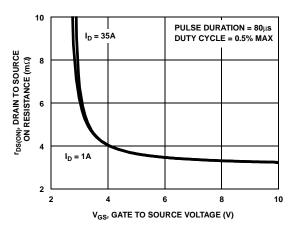


Figure 7. Transfer Characteristics

Figure 8. Saturation Characteristics



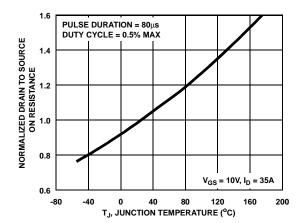


Figure 9. Drain to Source On Resistance vs Gate Voltage and Drain Current

Figure 10. Normalized Drain to Source On Resistance vs Junction Temperature

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# Typical Characteristics $T_C = 25$ °C unless otherwise noted

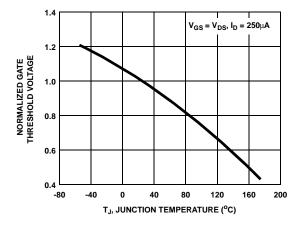


Figure 11. Normalized Gate Threshold Voltage vs
Junction Temperature

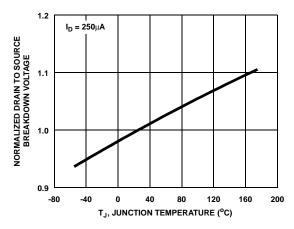


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

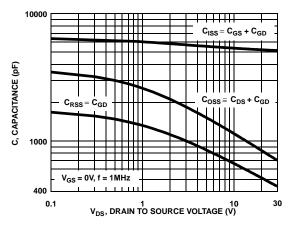


Figure 13. Capacitance vs Drain to Source Voltage

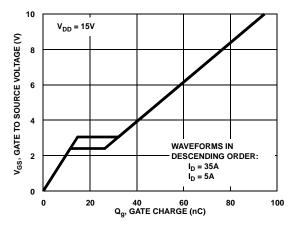


Figure 14. Gate Charge Waveforms for Constant Gate Current

# **Test Circuits and Waveforms**

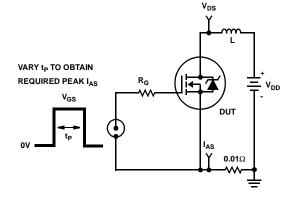


Figure 15. Unclamped Energy Test Circuit

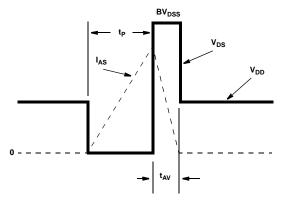


Figure 16. Unclamped Energy Waveforms

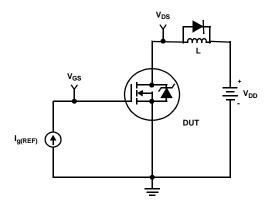


Figure 17. Gate Charge Test Circuit

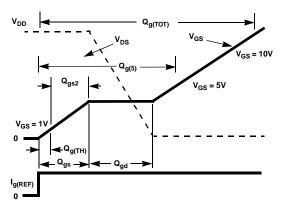


Figure 18. Gate Charge Waveforms

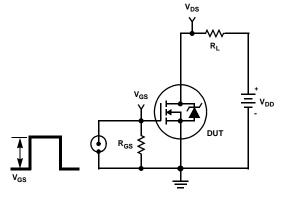


Figure 19. Switching Time Test Circuit

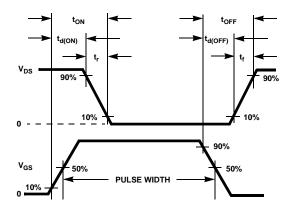


Figure 20. Switching Time Waveforms

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PSPICE Electrical Model
.SUBCKT FDP8870 2 1 3 ; rev December 2003
Ca 12 8 4.5e-9
Cb 15 14 4 5e-9
                                                                                                  LDRAIN
                                                             DPLCAP
                                                                                                          DRAIN
Cin 6 8 4.7e-9
                                                          10
Dbody 7 5 DbodyMOD
                                                                                                 RLDRAIN
                                                                      ₹RSLC1
Dbreak 5 11 DbreakMOD
                                                                                   DBREAK T
Dplcap 10 5 DplcapMOD
                                                           RSLC2
                                                                         FSI C
Ebreak 11 7 17 18 33.45
                                                                        50
Eds 14 8 5 8 1
Egs 13 8 6 8 1
                                                                                          17
18
                                                                                               ▲ DBODY
                                                                       RDRAIN
                                                                                  EBREAK
                                                    ESG
Esg 6 10 6 8 1
                                                              FVTHRFS
Evthres 6 21 19 8 1
                                                                \left(\frac{19}{8}\right)
Evtemp 20 6 18 22 1
                                                                                    MWFAK
                                    LGATE
                                                  EVTEMP
                             GATE
                                            RGATE
                                     ____
                                                    (18)
                                                                         ▼MMED
It 8 17 1
                                           9
                                                 20
                                                                  ✓MSTRO
                                    RI GATE
Lgate 1 9 3.6e-9
                                                                                                 LSOURCE
                                                                  CIN
                                                                                                          SOURCE
Ldrain 2 5 1.0e-9
Lsource 3 7 3.3e-9
                                                                                   RSOURCE
                                                                                                 RLSOURCE
RLgate 1 9 36
                                                                                       RBREAK
RLdrain 2 5 10
                                                      13
8
                                                                                               18
RLsource 3 7 33
                                                                                              ₹RVTEMP
                                                   S<sub>1</sub>B
                                                           o S2B
Mmed 16 6 8 8 MmedMOD
                                                                  СВ
                                                                                                19
                                              CA
Mstro 16 6 8 8 MstroMOD
                                                                                  IT
                                                                       14
Mweak 16 21 8 8 MweakMOD
                                                                                                 VBAT
                                                      EGS
                                                                EDS
Rbreak 17 18 RbreakMOD 1
                                                                                 8
Rdrain 50 16 RdrainMOD 2.15e-3
                                                                                       RVTHRES
Rgate 9 20 2.1
RŠLC1 5 51 RSLCMOD 1e-6
RSLC2 5 50 1e3
Rsource 8 7 RsourceMOD 9e-4
Rvthres 22 8 RvthresMOD 1
Rvtemp 18 19 RvtempMOD 1
S1a 6 12 13 8 S1AMOD
S1b 13 12 13 8 S1BMOD
S2a 6 15 14 13 S2AMOD
S2b 13 15 14 13 S2BMOD
Vbat 22 19 DC 1
ESLC 51 50 VALUE={(V(5,51)/ABS(V(5,51)))*(PWR(V(5,51)/(1e-6*500),10))}
.MODEL DbodyMOD D (IS=7.5E-12 IKF=17 N=1.01 RS=2.1e-3 TRS1=2e-3 TRS2=2e-7
+ CJO=1.9e-9 M=0.57 TT=9e-11 XTI=2.6)
.MODEL DbreakMOD D (RS=8e-2 TRS1=1e-3 TRS2=-8.9e-6)
.MODEL DplcapMOD D (CJO=1.75e-9 IS=1e-30 N=10 M=0.4)
.MODEL MmedMOD NMOS (VTO=2.1 KP=30 IS=1e-30 N=10 TOX=1 L=1u W=1u RG=2.1 T ABS=25)
.MODEL MstroMOD NMOS (VTO=2.51 KP=650 IS=1e-30 N=10 TOX=1 L=1u W=1u T ABS=25)
.MODEL MweakMOD NMOS (VTO=1.67 KP=0.1 IS=1e-30 N=10 TOX=1 L=1u W=1u RG=21 RS=0.1 T_ABS=25)
.MODEL RbreakMOD RES (TC1=8.3e-4 TC2=-9e-7)
.MODEL RdrainMOD RES (TC1=2.3e-3 TC2=5e-6)
.MODEL RSLCMOD RES (TC1=1e-4 TC2=1e-6)
.MODEL RsourceMOD RES (TC1=8e-3 TC2=1e-6)
.MODEL RvthresMOD RES (TC1=-2.3e-3 TC2=-9e-6)
.MODEL RytempMOD RES (TC1=-3e-3 TC2=2e-7)
.MODEL S1AMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-4 VOFF=-2)
.MODEL S1BMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-2 VOFF=-4)
.MODEL S2AMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-1 VOFF=-0.5)
.MODEL S2BMOD VSWITCH (RON=1e-5 ROFF=0.1 VON=-0.5 VOFF=-1)
FNDS
Note: For further discussion of the PSPICE model, consult A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global
Temperature Options; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank
Wheatley.
```

#### SABER Electrical Model rev December 2003 template FDP8870 n2,n1,n3 =m temp electrical n2,n1,n3 number m\_temp=25 var i iscl $dp..model\ dbodymod = \ (isl=7.5e-12,ikf=17,nl=1.01,rs=2.1e-3,trs1=2e-3,trs2=2e-7,cjo=1.9e-9,m=0.57,tt=9e-11,xti=2.6)$ dp..model dbreakmod = (rs=8e-2,trs1=1e-3,trs2=-8.9e-6) dp..model dplcapmod = (cjo=1.75e-9,isl=10e-30,nl=10,m=0.4) m..model mmedmod = $(type=_n, vto=2.1, kp=30, is=1e-30, tox=1)$ m..model mstrongmod = (type=\_n,vto=2.51,kp=650,is=1e-30, tox=1) m..model mweakmod = (type=\_n,vto=1.67,kp=0.1,is=1e-30, tox=1,rs=0.1) LDRAIN sw\_vcsp..model s1amod = (ron=1e-5,roff=0.1,von=-4,voff=-2) **DPLCAP** DRAIN sw\_vcsp..model s1bmod = (ron=1e-5,roff=0.1,von=-2,voff=-4) 10 sw\_vcsp..model s2amod = (ron=1e-5,roff=0.1,von=-1,voff=-0.5) RLDRAIN sw\_vcsp..model s2bmod = (ron=1e-5,roff=0.1,von=-0.5,voff=-1) RSLC1 c.ca n12 n8 = 4.5e-951 RSLC2 € c.cb n15 n14 = 4.5e-9ISCI c.cin n6 n8 = 4.7e-9DBRFAK T 50 dp.dbody n7 n5 = model=dbodymod RDRAIN <u>6</u> 8 dp.dbreak n5 n11 = model=dbreakmod **FSG** DBODY dp.dplcap n10 n5 = model=dplcapmod **EVTHRES** (<u>19</u>) 8 MWEAK LGATE **EVTEMP** spe.ebreak n11 n7 n17 n18 = 33.45 <sub>GATE</sub> RGATE 18 22 EBREAK spe.eds n14 n8 n5 n8 = 1 MMED MSTRO spe.egs n13 n8 n6 n8 = 1 RLGATE spe.esg n6 n10 n6 n8 = 1 LSOURCE spe.evthres n6 n21 n19 n8 = 1 CIN SOURCE spe.evtemp n20 n6 n18 n22 = 1 RSOURCE RLSOURCE i.it n8 n17 = 1 RBREAK I.lgate n1 n9 = 3.6e-917 I.Idrain n2 n5 = 1.0e-9RVTEMP o S2B I.Isource n3 n7 = 3.3e-919 CA IT (♠ 14 res.rlgate n1 n9 = 36 VBAT res.rldrain n2 n5 = 10 **EGS EDS** res.rlsource n3 n7 = 33 m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u, temp=m\_temp **RVTHRES** m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u, temp=m\_temp m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u, temp=m\_temp res.rbreak n17 n18 = 1, tc1=8.3e-4,tc2=-9e-7 res.rdrain n50 n16 = 2.15e-3, tc1=2.3e-3,tc2=5e-6 res.rgate n9 n20 = 2.1res.rslc1 n5 n51 = 1e-6, tc1=1e-4,tc2=1e-6 res.rslc2 n5 n50 = 1e3res.rsource n8 n7 = 9e-4, tc1=8e-3,tc2=1e-6 res.rvthres n22 n8 = 1, tc1=-2.3e-3,tc2=-9e-6 res.rvtemp n18 n19 = 1. tc1=-3e-3.tc2=2e-7sw\_vcsp.s1a n6 n12 n13 n8 = model=s1amod sw\_vcsp.s1b n13 n12 n13 n8 = model=s1bmod sw\_vcsp.s2a n6 n15 n14 n13 = model=s2amod sw\_vcsp.s2b n13 n15 n14 n13 = model=s2bmod v.vbat n22 n19 = dc=1 equations { $|sc| \cdot v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/500))** 10))$

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# **PSPICE Thermal Model** JUNCTION REV 23 December 2003 FDP8870T CTHERM1 TH 6 1e-3 CTHERM2 6 5 2e-3 CTHERM3 5 4 3e-3 RTHERM1 CTHERM1 CTHERM4 4 3 9e-3 CTHERM5 3 2 1e-2 CTHERM6 2 TL 2e-2 6 RTHERM1 TH 6 3e-2 RTHERM2 6 5 8e-2 RTHERM3 5 4 1.1e-1 RTHERM2 CTHERM2 RTHERM4 4 3 1.6e-1 RTHERM5 3 2 1.72e-1 RTHERM6 2 TL 2e-1 5 SABER Thermal Model SABER thermal model FDP8870T RTHERM3 CTHERM3 template thermal\_model th tl thermal\_c th, tl ctherm.ctherm1 th 6 =1e-3 ctherm.ctherm2 6 5 =2e-3 ctherm.ctherm3 5 4 =3e-3 ctherm.ctherm4 4 3 =9e-3 ctherm.ctherm5 3 2 =1e-2 RTHERM4 CTHERM4 ctherm.ctherm6 2 tl =2e-2 rtherm.rtherm1 th 6 =3e-2 rtherm.rtherm2 6 5 =8e-2 3 rtherm.rtherm3 5 4 =1.1e-1 rtherm.rtherm4 4 3 =1.6e-1 rtherm.rtherm5 3 2 =1.72e-1 RTHERM5 CTHERM5 rtherm.rtherm6 2 tl =2e-1 2 RTHERM6 CTHERM6 CASE tl





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